

2 The stationary Current Density and Flux

Student Group

First Name	Surname	Matrikel Nr.

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2. The stationary Current Density and Flux

For this chapter the online Book 'University Physics II' is strongly recommended as reference. In detail this is:

- Chapter [9.3 Model of Conduction in Metals](#)

At the discussion of the electrostatic field in principle no charges in motion were considered. Now the motion of charges shall be considered explicitly.

The current density here describes how charge carriers move together (collectively). The stationary current density describes the charge carrier movement, if a **direct voltage** is the cause of the movement. A constant direct current then flows in the stationary electric flow field. Thus there is no time dependence of the current:

$$\frac{dI}{dt} = 0$$

Also important is: Up to now was considered, charges did move through a field or could be moved in future. Now just the moment of the movement is considered.

2.1 Current Strength and Flux Field

Learning Objectives

By the end of this section, you will be able to:

1. sketch the flux field in a constricted and rectilinear conductor.
2. determine the flow velocity of electrons.
3. know the integral notation of the electric current.

Current and current density in a Simple Case

The current strength was previously understood as “charge per time” ($I = \frac{dQ}{dt}$). Microscopically, electric current is the directed motion of electric charge carriers. In the chapter [Basic concepts](#) we have already discussed the picture of the charge carrier current penetrating through a cross-sectional area A (see [figure 1](#)). Furthermore, we had quite practically applied Ohm's law with $R = \frac{U}{I}$ in DC. Now we know that the voltage in an electrostatic field can be derived from the electric field strength. But what about the current?

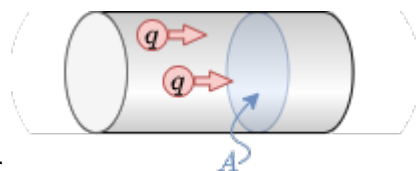
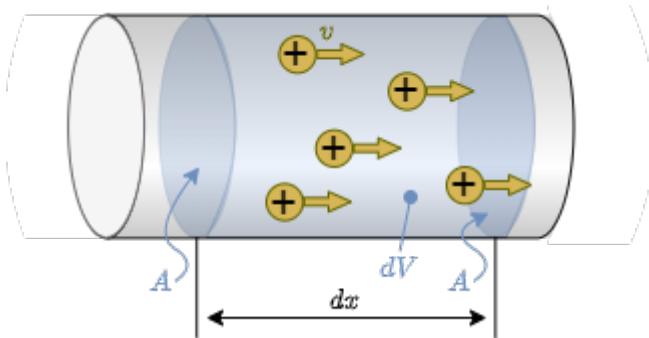


Fig. 1: part of a Conductor

For this purpose, a packet of charges dQ is considered, which will pass the area A during the period dt (see figure 2). These charges are located in a partial volume element dV , which is given by the area A to be traversed and a partial section dx : $dV = A \cdot dx$. The amount of charges per volume is given by the charge carrier density, specifically for metals by the electron density n_e . The electron density n_e gives the number of free electrons per unit volume a . For copper, for example, this is approximately $n_e(\text{Cu}) = 8.47 \cdot 10^{19} \frac{1}{\text{mm}^3}$.

Fig. 2: Charges in a partial volume in the conductor



The flowing charges contained in the partial volume element dV are then (with elementary charge e_0):

$$dQ = n_e \cdot e_0 \cdot A \cdot dx$$

The current is then given by $I = \frac{dQ}{dt}$:

$$I = n_e \cdot e_0 \cdot A \cdot \frac{dx}{dt} = n_e \cdot e_0 \cdot A \cdot v_e$$

This leads to an electron velocity v_e of:

$$v_e = \frac{dx}{dt} = \frac{I}{n_e \cdot e_0 \cdot A}$$

In contrast to the considerations in electrostatics, the charges now travel with finite velocities. With regard to the electron velocity $v_e \sim \frac{I}{A}$ it is obvious to determine a current density S (related to the area):

$$\boxed{S = \frac{I}{A}}$$

In some books, the letter j is alternatively used for current density.

Field lines and Equipotential Surfaces of the Current Density

The values of the current density can be given for any point in space. Therefore, the current density can also be considered as a field. As with the electrostatic field, a homogeneous field form and the inhomogeneous field form are to be contrasted:

1. In a **homogeneous current field** (e.g. conductor with constant cross-section) the field lines of the current run parallel. The equipotential surfaces are always perpendicular to each other,

because the potential energy of a charge depends only on its position along the path.

Additionally, the equipotential surfaces are equidistant due to the homogeneous geometry and the constant electric field, which causes the current.

Therefore the current $I = S \cdot A$ is constant

$\Rightarrow$ the charge carriers have the same velocity v

2. In an **inhomogeneous current field** (e.g. a fuse or bottleneck in a wire) the field lines of the current are not parallel. the current $I = S \cdot A$ along the wire must also be constant, because the charge does not disappear or appear from nothing, but the area A becomes smaller.

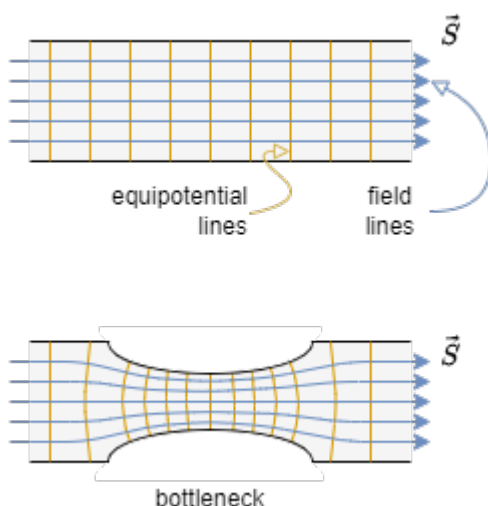
$\Rightarrow$ thus the current density S and the velocity v at the bottleneck must become larger.

The equipotential surfaces are again perpendicular to the current density. The current does now show a compression at the bottleneck.

But why is there a compression of the equipotential surfaces at a bottleneck (see [figure 3](#))?

This means that there is a large potential difference, i.e. a large voltage. So, this already sounds a little bit plausible. This will be looked at in more detail in a moment.

Fig. 3: Field Lines and equipotential Surfaces of the electric Current Field



The current density was determined only for a constant cross-sectional area A , through which a homogeneous current - thus also a homogeneous current field - passes at perpendicularly. Now however, a general approach for the electric current strength has to be found.

For this purpose, instead of a constant current density S over a vertical, straight cross-sectional area A , a varying current density $S(A)$ over many small partial areas dA is considered. Thus, if the subareas are sufficiently small, a constant current density over the subarea can again be obtained. It then becomes

$$\begin{aligned} I &= S \cdot A \Rightarrow dI = S \cdot dA \end{aligned}$$

The total current over a larger area A is thus given as:

$$\begin{aligned} I &= \int dI = \iint_A S \cdot dA \end{aligned}$$

But what was not considered here: The chosen area A does not necessarily have to be perpendicular to the current density $\vec{S}$. To take this into account, the (partial) surface normal vector $d\vec{A}$ can be used. If only the part of the current density $\vec{S}$ is to be considered which acts in the direction of $d\vec{A}$, this can be determined via the scalar product:

$$\begin{aligned} I = \int dI = \iint_A \vec{S} \cdot d\vec{A} \end{aligned}$$

This represents the integral notation of the electric current strength. This can be used to determine the current strength in any field. The current I is the flux of the current density vector $\vec{S}$.

General Material Law

For a “pragmatic” derivation of the general material law for the current density, the compression of the equipotential surfaces at the constriction shall be discussed again. Between two equipotential surfaces there is a voltage difference ΔU . If one chooses this sufficiently small, the transition of $\Delta U \rightarrow dU$ results again. However, the same current I must always flow through the potential surfaces in the conductor. Ohm's law then gives the partial resistance dR between the two equipotential surfaces:

$$\begin{aligned*} dU = I \cdot dR \tag{2.1.1} \end{aligned*}$$

The individual quantities are now to be considered for infinitesimally small parts. For I an equation about a density - the current density - was already found:

$$\begin{aligned*} I = S \cdot A \tag{2.1.2} \end{aligned*}$$

But also R has already been expressed by a “density” - the resistivity ϱ : $R = \varrho \cdot \frac{L}{A}$

If a conductor made of the same material is considered, the resistivity ϱ is the same everywhere. But if there is now a partial element ds along the conductor, where the cross-section A is smaller, the resistance dR of this partial element also changes. The partial resistance is then:

$$\begin{aligned*} dR = \varrho \cdot \frac{ds}{A} \tag{2.1.3} \end{aligned*}$$

In concrete terms, this means for the bottleneck: **The resistance increases at the bottleneck. Thus the voltage drop also increases there. Thus there are also more equipotential surfaces there.**

This solves the question, why there is a compression of the equipotential surfaces at the bottleneck (cmp. [figure 2](#)). Interestingly, the thought model can now also for a homogeneous body explain the general material law. To do this, one inserts equation $(2.1.2)$ and $(2.1.3)$ into $(2.1.1)$. Then it follows:

$$\begin{aligned*} dU = I \cdot dR = S \cdot A \cdot \varrho \cdot \frac{ds}{A} = \varrho \cdot S \cdot ds \end{aligned*}$$

If now the electric field strength is inserted as $E = \frac{dU}{ds}$, one obtains:

$$\begin{aligned*} E = \frac{dU}{ds} = \varrho \cdot S \end{aligned*}$$

With a more detailed (and mathematically correct) derivation you get:

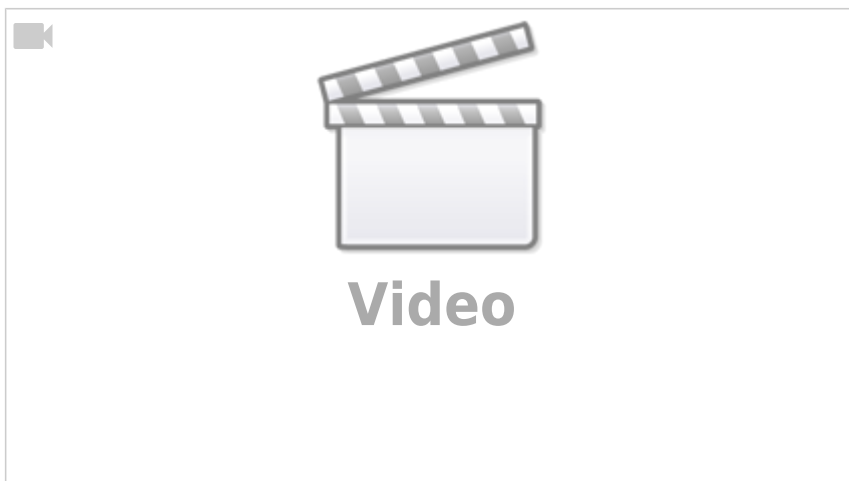
$$\boxed{\vec{E} = \varrho \cdot \vec{S}}$$

This equation expresses how the electric field $\vec{E}$ and the (stationary) current density $\vec{S}$ are related: both point in the same direction. For a given electric field $\vec{E}$ in a homogeneous conductor, the smaller the resistivity ϱ , the larger the current density $\vec{S}$.

Tasks

Task 2.1.1 calculated exercises in video

Examples of electrical current density



Task 2.1.2 Electron velocity in copper

A current of $I = 2\text{A}$ flows in a conductor made of copper with cross-sectional area A . The electron density in copper is $n_e(\text{Cu}) = 8.47 \cdot 10^{19} \text{ } \{ \{1\} \over \text{mm}^3 \}$ and the magnitude of the elementary charge $e_0 = 1.602 \cdot 10^{-19} \text{ As}$

1. What is the average electron velocity $v_{e,1}$ of electrons when the cross-sectional area of the conductor is $A = 1.5\text{mm}^2$?
2. What is the average electron velocity $v_{e,1}$ of electrons when the cross-sectional area of the conductor is $A = 1.0\text{mm}^2$?

Task 2.1.3 Electron velocity in Semiconductors

Similar to the task 2.1.2 a current of $I = 2\text{A}$ shall flow through a cross-sectional area $A = 1.5\text{mm}^2$ of semiconductors.
(magnitude of the elementary charge $e_0 = 1.602 \cdot 10^{-19} \text{ As}$)

1. What is the average electron velocity $v_{e,1}$ of electrons for undoped silicon (electron density $n_e(\text{Si}) = 9.65 \cdot 10^9 \text{ } \{ \{1\} \over \text{cm}^3 \}$ at room temperature)?
2. The electron density of doped silicon $n_e(\text{Si}; \text{doped})$ is (mainly) given by the numbers

of dopant atoms per volume. The doping shall provide 1 donator atom per 10^7 silicon atoms (here: one donator atom shall release one electron). The molar volume of silicon is $12 \cdot 10^{-6} \text{ m}^3/\text{mol}$ with $6.022 \cdot 10^{23}$ silicon atoms per mol . What is the average electron velocity $v_{e,1}$ of electrons for doped silicon?

2.2 Gauss's Law for Current Density

Targets

After this lesson, you should:

1. know which quantities are comparable for the electrostatic field and the flow field.
2. be able to explain the displacement current on the basis of enveloping surfaces.
3. understand how current can flow “through” a capacitor.

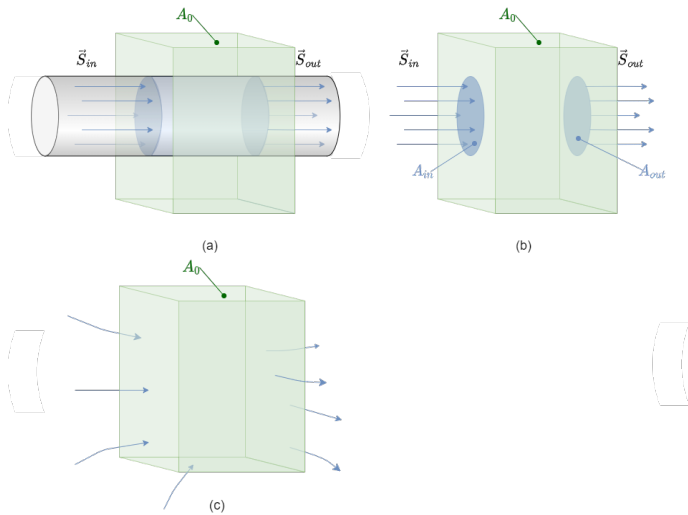
One can now compare the formulas of the current density with the formulas of the displacement flux density. Interestingly, these have a similar structure (see [figure 4](#)). However, the Gauss's law for the current density was not considered up to now.

Fig. 4: Comparison of the electrostatic Field and Current Density

Electrostatic Field		vs	"Electric Flow Field"	
Displacement Flux Density	$\vec{D}$ $D = \frac{d\Psi}{dA}$		$\vec{S}$ $S = \frac{dI}{dA}$	Current Density
Displacement Flux	$\Psi = \iint_A \vec{D} d\vec{A}$		$I = \iint_A \vec{S} d\vec{A}$	Current
Gauss's law	$Q = \oiint_A \vec{D} d\vec{A}$		?	Gauss's law

The Gauss's law of the current density shall be analyzed now. [figure 5 a\)](#) shows a closed surface around a part of the wire. Since the charge has to be conserved, the incoming current $I_{in} = S_{in} \cdot A_{in} = \frac{dQ_{in}}{dt}$ must be equal to the outgoing current $I_{out} = S_{out} \cdot A_{out} = \frac{dQ_{out}}{dt}$ ([figure 5 b](#)). This is also true for any arbitrary current density going through the surface, see [figure 5 c](#)).

Fig. 5: Gauss's Law for Current Density

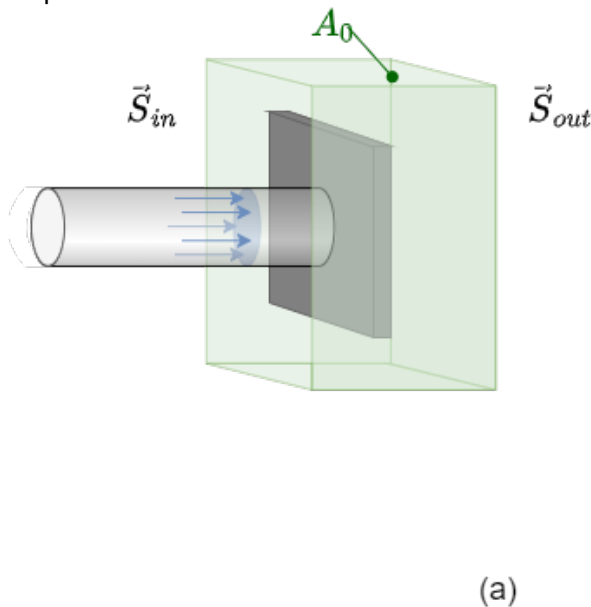


Thus, for the integral of current density over the closed surface A it must apply that:

$$\begin{aligned} I_{A_0} &= \int_{A_0} dI = \int_{A_0} \vec{S} \cdot d\vec{A} = 0 \end{aligned}$$

But, how do the charges “flow” through a capacitor? Or more explicit: What happens, when we look onto a closed surface enveloping only one plate of the capacitor? There is only one incoming current, but no outgoing. Between the plate inside of the dielectrics there are no moving charges. How shall this work?

Fig. 6: Gauss's Law for Current Density for a Capacitor Plate



For this, also the displacement flux density D has taken into account. Since on the capacitor plate the ingoing charges gets enriched (or depleted) there will be a continuous increase of the displacement flux Ψ (which is directly related to the charge Q). The ingoing current $I = \frac{dQ}{dt}$ lead to a constant $\frac{d\Psi}{dt}$ in the dielectric. As more displacement flux gets created, as more charges will be induced on the other plate. This also lead to a current from / towards the other plate into the attached wire. Correspondingly, the change of the displacement flux behaves like a current!

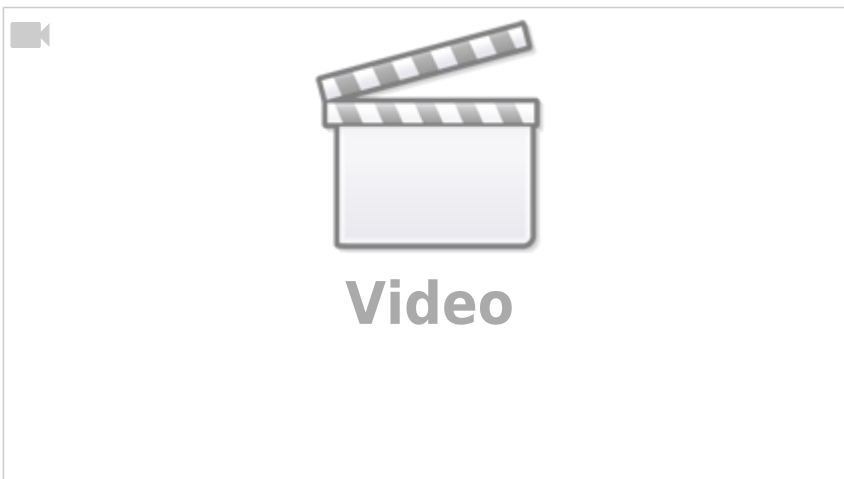
This current type within the dielectric material is called **displacement current**:

$$\begin{aligned} I_d = \frac{d\Phi}{dt} \end{aligned}$$

This type of current is different to the previous concept of current, where charges are always continuously moving - the **conduction current**. The conduction current $I_c = \frac{dQ}{dt}$ obeys a fixed relationship to the voltage (e.g. the Ohm's Law for linear components). The displacement current does not obey such a relationship, due to the enrichment / depletion of charges. On a plate the conduction current gets converted into displacement current, and vice versa.

When speaking of electric current, one often covers both types of currents: $I = I_c + I_d$.

There is also another important indication, which proves that the displacement current acts like a "charge-free" current: Any current generates a magnetic field around its way through the conductor. This is also true for the displacement current. When extrapolating this into fast alternating displacement flux density this explains the electromagnetic wave. There, the change in the electric field creates a changing magnetic field, which creates a changing electric field, which creates a changing electric field, which ...



Tasks

Task 2.2.1 Simulation

In the simulation program of [Falstad](#) can be represented by equipotential surfaces, electric field strength and current density in different objects.

1. Open the simulation program via the link
2. Select: "Setup: Wire w/ Current" and "Show Current (j)".
3. You will now see a finite conductor with charge carriers starting at the top end and arriving at the bottom end.
4. We now want to observe what happens when the conductor is tapered.
 1. To do this, select "Mouse = Clear Square". You can now use the left mouse button to remove parts from the conducting material. The aim should be, that in the middle of the Conductor there is only a one box wide line, on a length of at least 10 boxes. If you want to add conductive material again, this is possible with "Mouse = Add - Conductor".

2. Consider why more equipotential lines are now accumulating as the conductor is tapered.
3. If you additionally draw in the E-field with "Show E/j", you will see that it is stronger along the taper. This can be checked with the slider "Brightness". Why is this?
5. Select "Setup: Current in 2D 1", "Show E/rho/j". Why doesn't the cavity behave like a Faraday cage here?

Task 2.2.2 Water Resistor

In transformer stations sometimes water resistors are used as [Liquid rheostat](#). In this resistor the water works as a (poor) conductor which can handle a high power loss.

The water resistor consists of a water basin. In the given basin two quadratic plates with the edge length of $l = 80 \text{ cm}$ are inserted with the distance d between them. The resistivity of the water is $\rho = 0.25 \text{ } \Omega \text{ m}$. The resistor shall dissipate the energy of $P = 4 \text{ kW}$ and shall exhibit a homogenous current field.

1. Calculate the required distance of the plates in order to get a current density of $S = 25 \text{ mA/cm}^2$
2. What are the values of the current I and the voltage U at the resistor, such as the internal electric field strength E in the setup?

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